MOSFET

6A,900V 1.9Ω N-CHANNEL Power MOSFET

Features

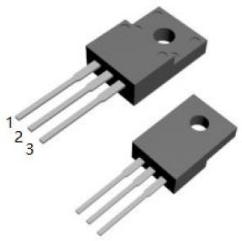
- Low gate charge
- Fast Switching
- Excellent Low Ciss

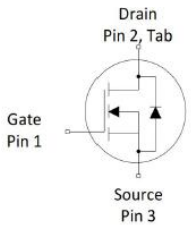
Applications

- Synchronous Rectification for AC/DC Quick Charger
- Battery management
- Electronic transformer
- UPS (Uninterrupible Power Supplies)

View and Internal Schematic Diagram

TO-220F-3L





Parameter	Values	Unit
BV_{DSS}	900	V
I_D	6	A
R_{Dson}(max)	1.9	Ω
$V_{GS(th)}$(Typ)	4	V

Ordering Code	Marking	Package	Packaging
X6N90DHC3	X6N90DHC3	TO-220F	Tube

Absolute Maximum Ratings(T_C=25℃,unless otherwise noted)

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Drain-Source Voltage	V_{DSS}	-	-	900	V	-
Gate-Source Voltage	V_{GS}	-30	-	30	V	-
Continuous Drain Current(Note 1)	I_D	-	-	6	A	T_C=25℃
Pulsed Drain Current(Note 2)	I_{DM}	-	-	14	A	-
Single Pulse Avalanche Energy	E_{AS}	-	-	451	mJ	L=10mH,V_D=50V, T_C=25℃
Maximum Power Dissipation	P_D	-	-	64	W	T_C=25℃
		-	-	2.5	W	T_A=25℃
Operating Junction and Storage Temperature Range	T_j,T_{STG}	-55	-	150	℃	-

Thermal Characteristics

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Thermal resistance , Junction to Case	$R_{th(J-c)}$	-	1.94	-	℃/W	-
Thermal resistance , Junction to Ambient	$R_{th(J-a)}$	-	49	-	℃/W	-

Electrical Characteristics (T_j=25℃,unless otherwise noted)

Static characteristics

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Drain-Source Breakdown Voltage	BV_{DSS}	900	-	-	V	V_{GS}=0V,I_D=250μA
Zero Gate Voltage Drain Current	I_{DSS}	-	-	1	μA	V_{DS}=900V,V_{GS}=0V
Gate-Body Leakage Current,Forward	I_{GSSF}	-	-	100	nA	V_{GS}=30V,V_{DS}=0V
Gate-Body Leakage Current,Reverse	I_{GSSR}	-	-	-100	nA	V_{GS}=-30V,V_{DS}=0V
Gate-Source Threshold Voltage	$V_{GS(th)}$	2.0	-	4.0	V	V_{DS}=V_{GS},I_D=250μA
Drain-Source On-State Resistance	$R_{DS(on)}$	-	1.7	1.9	Ω	V_{GS}=10V,I_D=3A
Gate Resistance	R_g	-	1	-	Ω	V_{GS}=0V, V_{DS}=0V, f=1MHz
Forward Transconductance	g_{fs}	-	7	-	S	V_{DS}=10V,I_D=3A

Dynamic characteristics

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Input Capacitance	C_{iss}	-	1575	-	pF	V_{DS}=25V,V_{GS}=0V,f=1.0MHZ
Output Capacitance	C_{oss}	-	117	-		
Reverse Transfer Capacitance	C_{rss}	-	4	-		
Turn-On Delay Time	$t_{d(on)}$	-	14	-	ns	V_{DD}=450V,I_D=6A,V_{GS}=10V,R_G=9.1Ω
Turn-On Rise Time	t_r	-	16	-		
Turn-Off Delay Time	$t_{d(off)}$	-	27	-		
Turn-Off Fall Time	t_f	-	39	-		

Gate charge characteristics

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Total Gate Charge	Q_g	-	27	-	nC	V_{DS}=450V,I_D=6A,V_{GS}=10V
Gate-Source Charge	Q_{gs}	-	10	-		
Gate-Drain Charge	Q_{gd}	-	7	-		

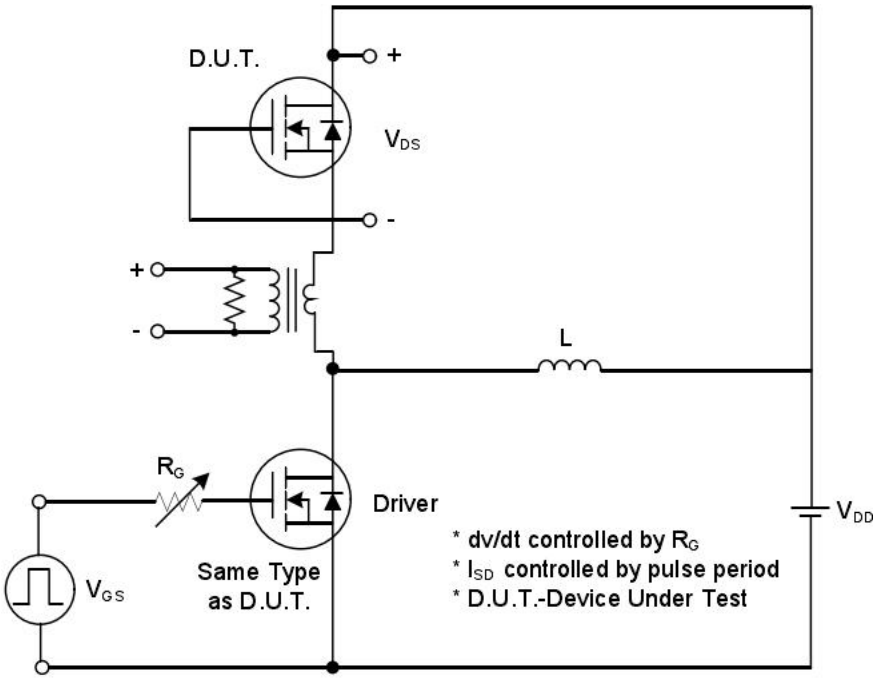
Diode Characteristic

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Continuous Diode Forward Current	I_S	-	-	6	A	-
Pulsed Diode Forward Current	I_{SM}	-	-	14	A	-
Diode Forward Voltage	V_{SD}	-	-	1.2	V	I_S=3A,V_{GS}=0V
Reverse Recovery Time	t_{rr}	-	754	-	ns	V_{GS}=0V,I_s=6A
Reverse Recovery Charge	Q_{rr}	-	4.3	-	uC	di/dt=100A/μs

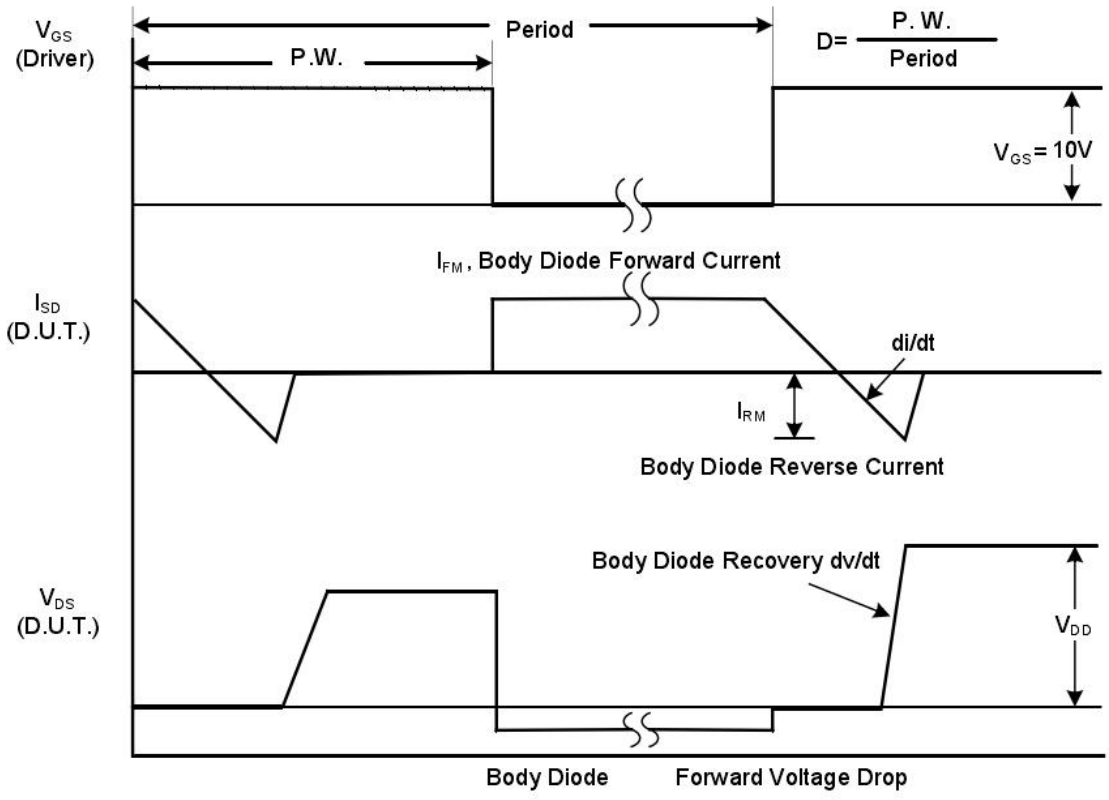
Note:

1. Limited by $T_{J\,MAX}$ < 150℃, Maximum Duty Cycle D=0.5, TO-220 equivalent.
2. This single-pulse measurement was taken under T_{j_Max} = 150°C.

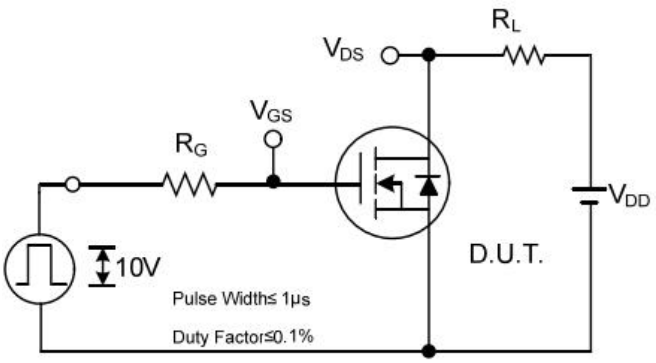
RATING AND CHARACTERISTIC CURVES



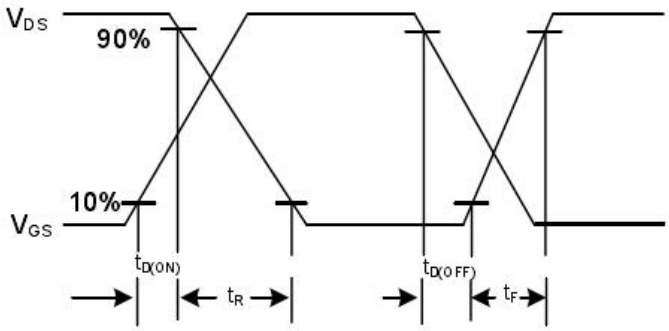
Peak Diode Recovery dv/dt Test Circuit



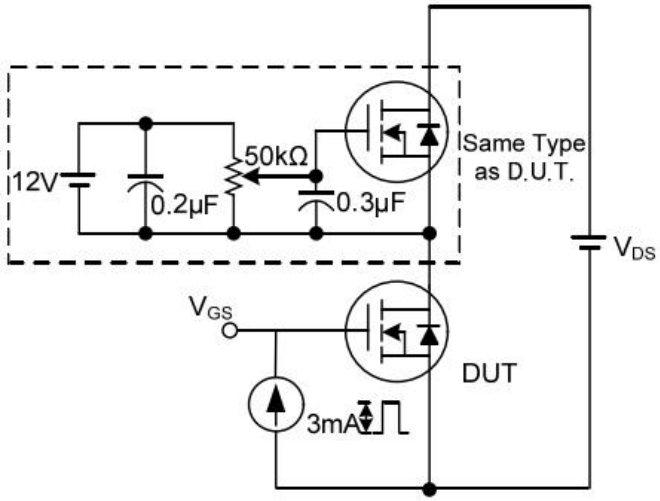
Peak Diode Recovery dv/dt Waveforms



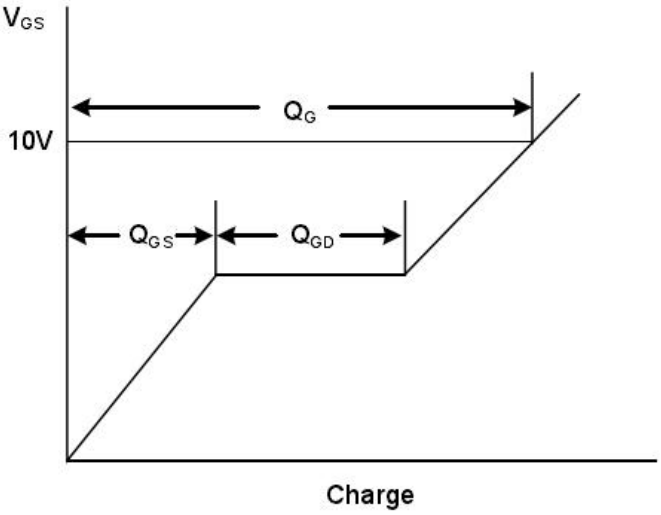
Switching Test Circuit



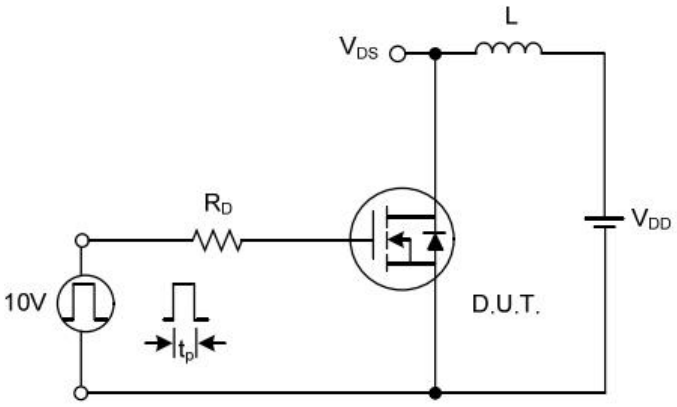
Switching Waveforms



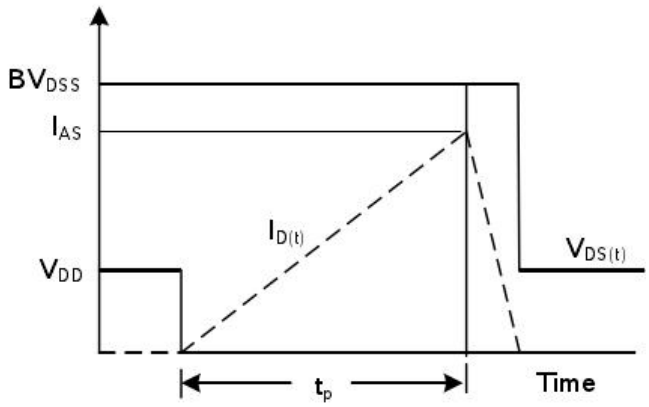
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

RATING AND CHARACTERISTIC CURVES

Figure.1 Output Characteristics T_j=25℃

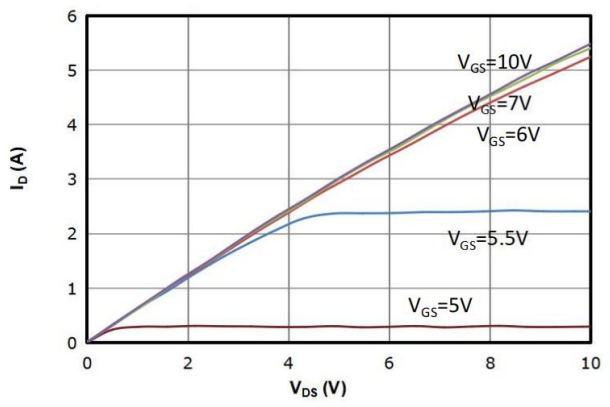


Figure.2 Transfer Characteristic for Various Junction Temperatures

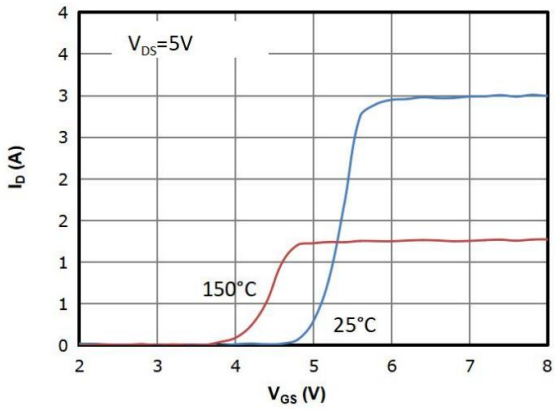


Figure.3 On-Resistance vs Drain Current For Various Gate Voltage

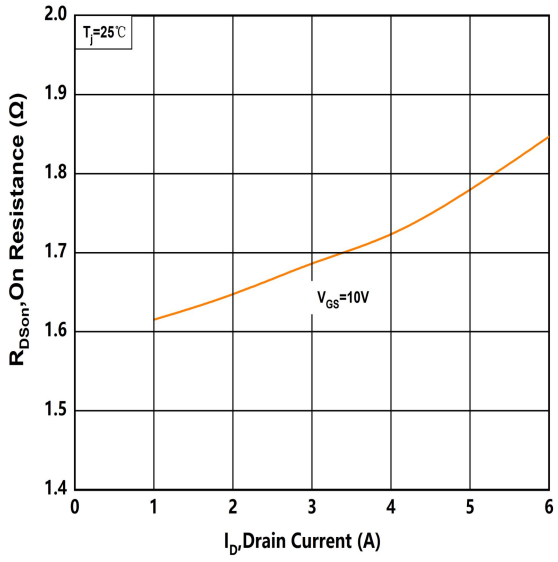


Figure.4 Typical On-Resistance vs Junction Temperature

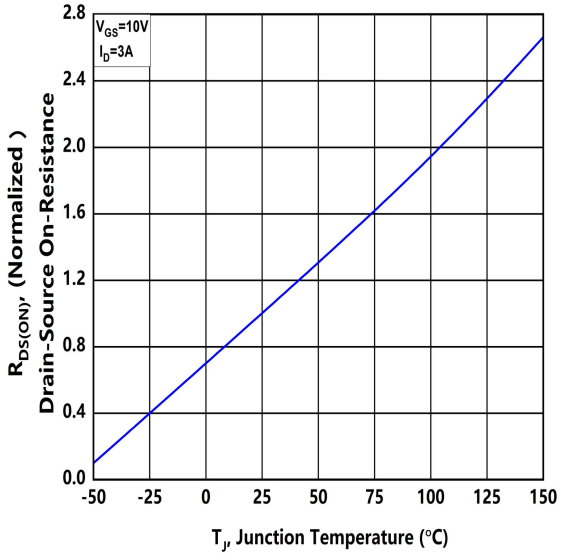


Figure.5 Typical Threshold Voltage vs Junction Temperature

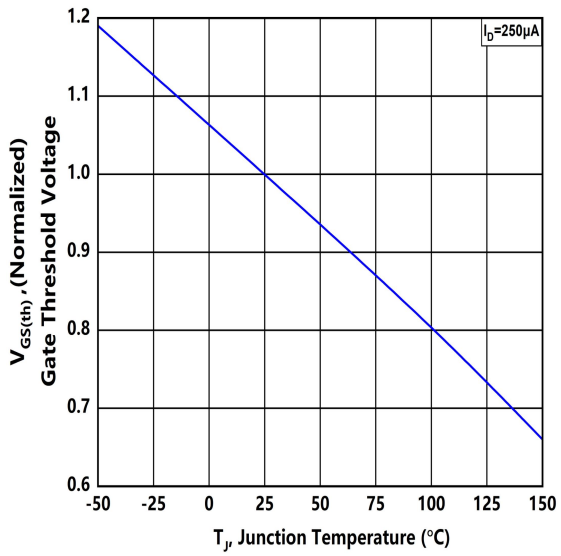


Figure.6 Typical Breakdown Voltage vs Junction Temperature

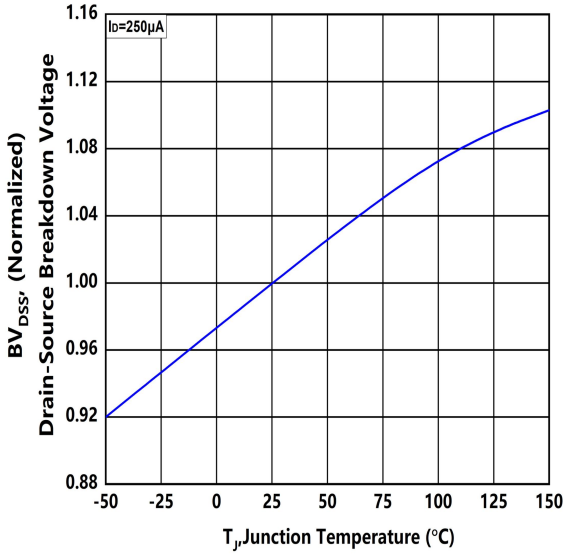


Figure.7 Typical Capacitance vs Drain to Source Voltage

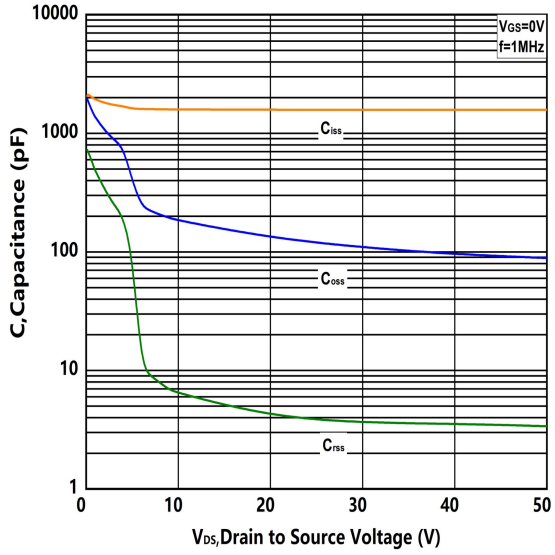


Figure.8 Typical Gate Charge vs Gate to Source Voltage

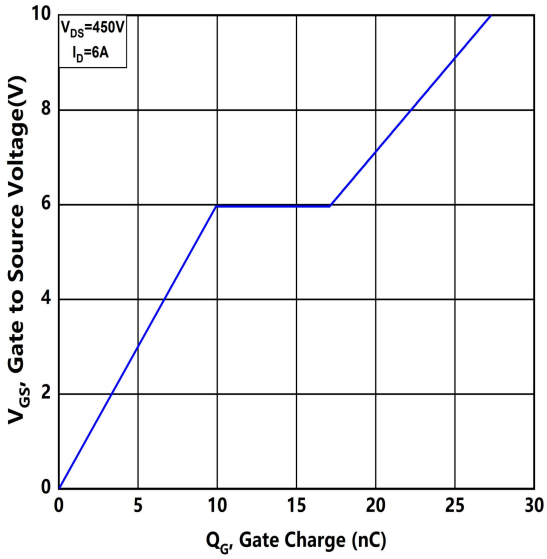


Figure.9 Typical Body Diode Characteristics

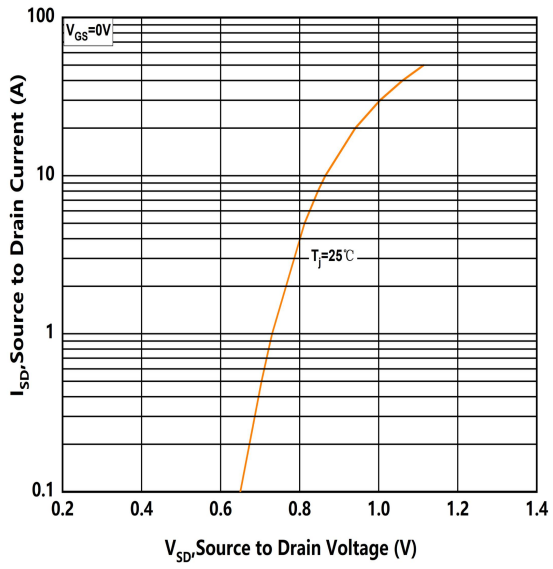


Figure.10 Maximum power Dissipation Derating vs Case Temperature

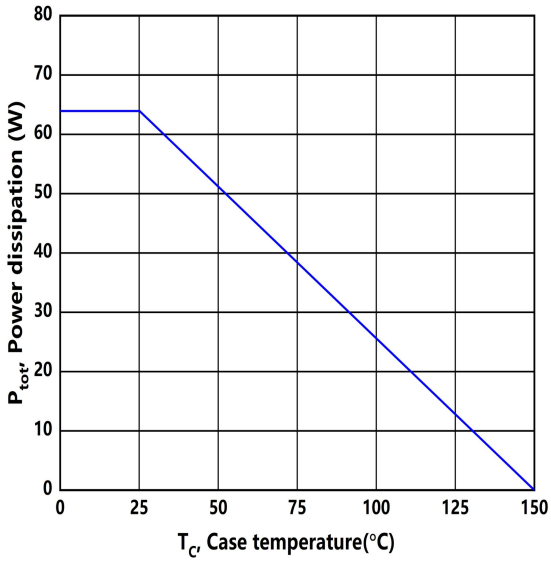


Figure.11 Safe Operating Area

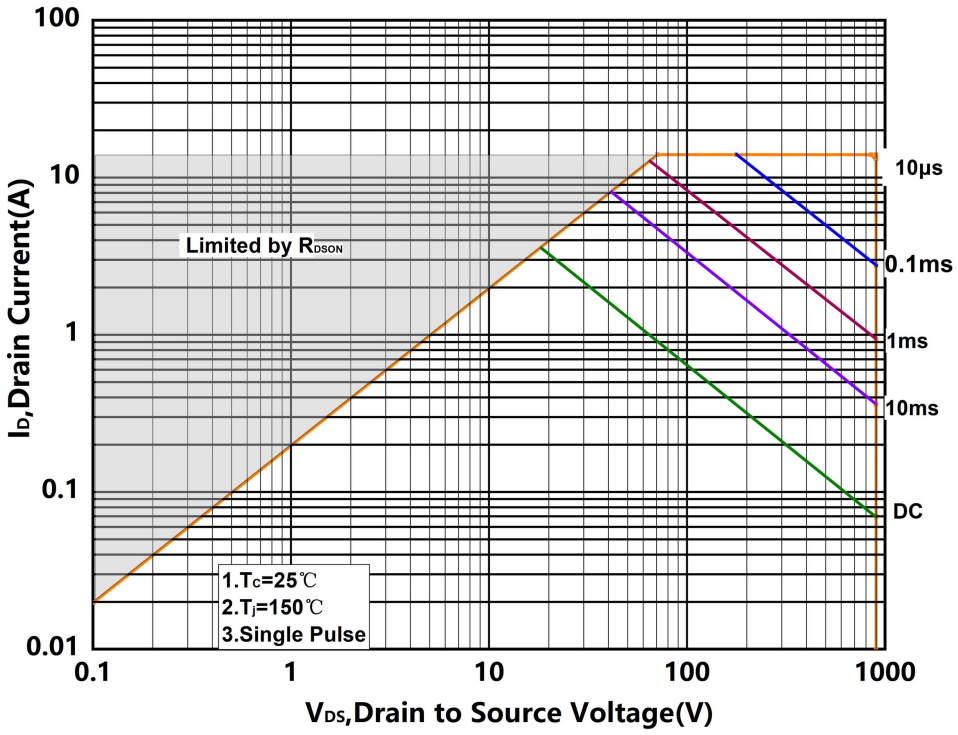
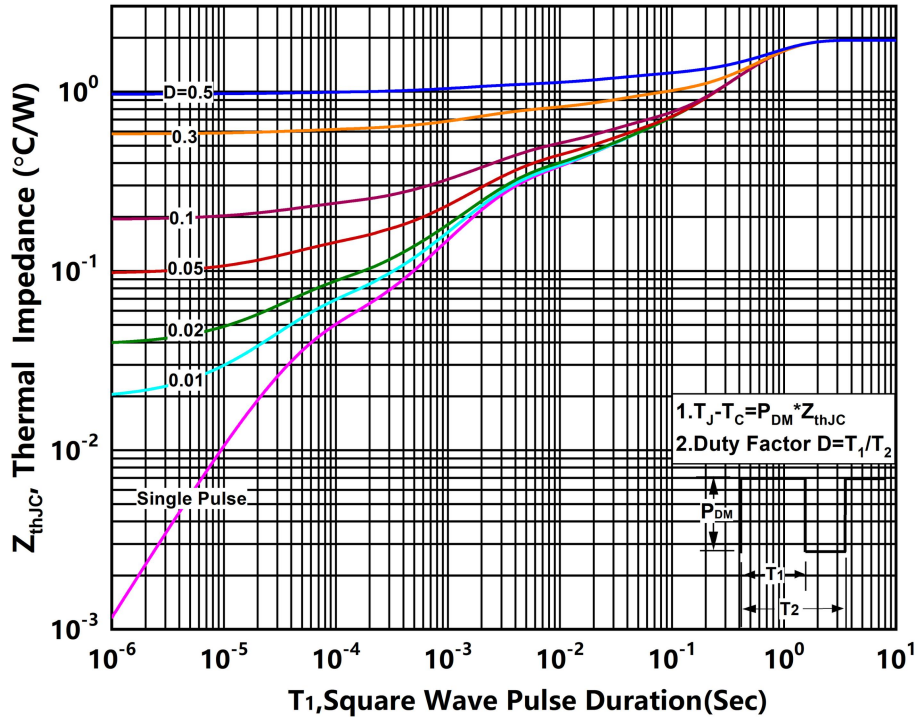
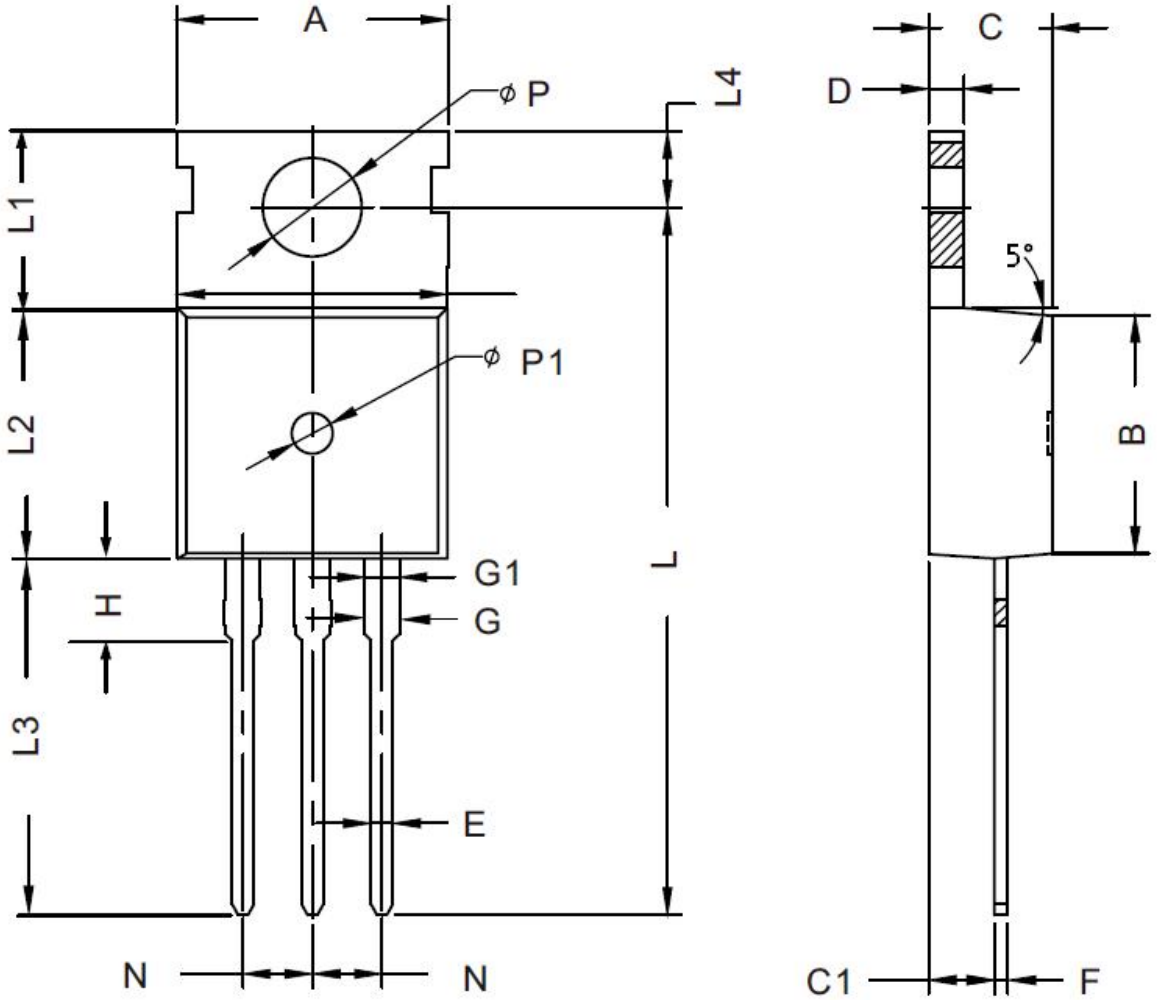


Figure.12 Transient Thermal Impedance (Junction - Case)



Package Outline:TO-220-3L



Symbol	Millimeters		Symbol	Millimeters	
	Min	Max		Min	Max
A	9.60	10.3	H	2.70	3.30
B	8.40	9.00	L	25.90	26.50
C1	2.20	2.60	L1	6.30	6.70
C	4.30	4.70	L2	9.00	9.40
D	1.20	1.40	L3	12.50	14.10
E	0.70	0.90	L4	2.70	2.90
F	0.40	0.60	N	2.50	2.58
G	1.20	1.50	ΦP	3.50	3.70
G1	1.10	1.40	ΦP1	1.40	1.60